| ASSOCIATION ELECTRONICS | CONNECTING INDUSTRIES® | PC, Bannockb | ourn, Illinois. A | All rights reserved untions. | under both | This docume level parts, t | ent is a declarati he declaration e | on of the sub- ncompasses a | stances w all lower l | ithin the manufactur evel materials for w | rer listed i hich the n | tem. Note: if nanufacturer | the item is an as has engineering | ssembly with low responsibility. |
|----------------------------|--|---------------------------|---------------------------------|------------------------------|--|-------------------------------|--|--------------------------------|--------------------------|--|---------------------------------|-------------------------------|-----------------------------------|----------------------------------|
| 752-21.1 | IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute | | | | * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi | | | | | als and Mfg Information | | | | |
| upplier | Information | | | | | | | | | | | | | |
| Company name* Company | | | | y unique ID | | | Unique ID Authority | | | | Response Date* | | | |
| onsemi | | | | | | | | | | | 2024-05-11 | | | |
| Contact Name | | | Title - Contact | | | | Phone - Contact* | | | | Email - Contact* | | | |
| Product-E | nv-Stewards | | Product Enviro Compliance | | | | NA | | | | Product-Env-Stewards@onsemi.com | | | |
| Authorized Representative* | | | Title - Representative | | | | Phone - Representative* | | | | Email - Representative* | | | |
| roduct-Ei | nv-Stewards | Product Enviro Compliance | | | | NA | | | | Product-Env-Stewards@onsemi.com | | | | |
| | Requester Item Number Mfr Item Number 1N4734A | | Number Mfr Item Name | | | | Effective Date | Version | Ma | Manufacturing Site | | Weight* | UOM | Unit Type |
| | | | A | 5.6V 1W 5% ZENER DO41 | | | 2024-05-11 CN2 | | | 324.186 | mg | Each | | |
| Ianufac | turing Proccess Informat | tion | | | | | | | | | | | | |
| 7 | Terminal Plating / Grid Array Material | | Ferminal Base Alloy J-STD-020 N | | J-STD-020 MSI | L Rating | Peak Process Body Temperature | | Max Time at Peak | Temperat | ure Numb | er of Reflow Cyc | cles | |
| Matte Tin (Sn) - annealed | | U Alloy NA | | | 0 C | | 30 | secon | ds 3 | | | | | |
| omments | | | | | | | | | | | | | | |
| | | | | | | | | | | | | | | |
| or more ir | nformation regarding material | composition | please refer to | o page 3 | | | | | | | | | | |

| RoHS Material Composition Declaration | | | | Declaration Type * | Detailed | | | | | | |
|---|---|--|--|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS Directive 2011/65/EU | amending RoHS RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). | | | | | | | | | | |
| cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexcess encompass all such components.Supplier cert as of the date that Supplier completes this for Company acknowledges that Supplier may ha independently verified information provided certification in this paragraph.If the Company | ted biphenyls and/or polybrominated dip of an applicable quantity limit, please in ifies that it gathered the information it pr m.Supplier acknowledges that Company ve relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr source of the Supplier's liability and the | henyl ethers (each a "RoHS restricted subs ndicate below which, if any, RoHS exempt ovides in this form using appropriate meth will rely on this certification in determinin ers in completing this form, and that Suppl num, itssuppliers have provided certificatio eement with respect to the identified part,t Company's remedies for issues that arise r | stance") in exce ion you believe ods to ensure i g the compliar ier may not ha ons regarding t he terms and co | ropean Union member states) of the part identifiess of the applicable quantity limit identified able may apply. If the part is an assembly with low is accuracy and that such information is true and ce of its products with European Union member independently verified such information. How heir contributions to the part, and those certifica onditions of that agreement, including any warra nation the Supplier provides in this form. In the | ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the inty rights and/or remedies provided as part of | | | | | | |
| RoHS Declaration * 4 - Item(s |) does not contain RoHS restricted subst | ances per the definition above except for se | elected exempt | ions Supplier Acceptance | * Accepted | | | | | | |
| Exemption: 7c-I Electrical and electronic c | omponents containing lead in a glass o | r ceramic other than dielectric ceramic | in capacitors, | e.g. piezoelectronic devices, or in a glass or c | eramic matrix compound. | | | | | | |
| Exemption List Version | EL-2011/534/EU | | | | | | | | | | |
| Declaration Signature | | | | | | | | | | | |
| Instructions: Complete all of the required Requester) and click on Submit Form to ha | | | ice drop-dowi | n. This will display the signature area. Digital | ly sign the declaration (if required by the | | | | | | |
| Supplier Digital Signature R | astislav Drska | Le | | | | | | | | | |

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level | Substance | CAS | Exempt | Weight | Unit of Measure |
|----------------------|---------|-----------------|----------|---------------------------|------------|--------|---------|-----------------|
| CSS Wire | 202.316 | mg | Supplier | Sulfur (S) | 7704-34-9 | | 0.1012 | mg |
| | | | Supplier | Carbon (C) | 7440-44-0 | | 1.0116 | mg |
| | | | Supplier | Manganese (Mn) | 7439-96-5 | | 0.4046 | mg |
| | | | Supplier | Iron (Fe) | 7439-89-6 | | 129.988 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 70.7094 | mg |
| | | | Supplier | Phosphorus (P) | 7723-14-0 | | 0.1012 | mg |
| Die | 0.093 | mg | Supplier | Silicon (Si) | 7440-21-3 | | 0.093 | mg |
| Dumet Wire | 57.927 | mg | Supplier | Manganese (Mn) | 7439-96-5 | | 0.5213 | mg |
| | | | Supplier | Silicon (Si) | 7440-21-3 | | 0.2317 | mg |
| | | | В | Nickel (Ni) | 7440-02-0 | | 18.3339 | mg |
| | | | Supplier | Iron (Fe) | 7439-89-6 | | 25.2851 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 13.5549 | mg |
| Glass Encapsulation | 60.33 | mg | Supplier | Boron Trioxide (B2O3) | 1303-86-2 | | 1.8099 | mg |
| | | | А | Lead Oxide (PbO) | 1317-36-8 | 7c | 36.922 | mg |
| | | | В | Antimony Trioxide (Sb2O3) | 1309-64-4 | | 0.0302 | mg |
| | | | Supplier | Potassium Monoxide (K2O) | 12136-45-7 | | 2.2624 | mg |
| | | | Supplier | Silica Crystalline (SiO2) | 14808-60-7 | | 19.3056 | mg |
| Plating | 3.52 | mg | Supplier | Tin (Sn) | 7440-31-5 | | 3.52 | mg |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).